



TARIFS IFTEC DES STANDARDS IPC

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IFTEC : 33 rue Ravon - 92340 BOURG-LA-REINE - France
Tel : +33 01 45 47 02 00 Mail : iftec@iftec.fr Site : www.iftec.fr
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TARIF IFTEC STANDARDS IPC AU 14 mai 2024

Coût Transport / Emballage

Colissimo France :		Colissimo étranger (zone A - Zone B) :		
poids < 500g	16€	27€	40€	poids < 500g
poids > 500g < 1kg	19€	33€	48€	poids > 500g < 1kg
poids > 1kg < 2kg	21€	38€	53€	poids > 1kg < 2kg
poids > 2kg < 5kg	30€	48€	68€	poids > 2kg < 5kg
poids > 5kg < 10kg	44€	79€	112€	poids > 5kg < 10kg

		REF IPC	Poids gr	PRIX €	TITRE
1072	LIV	IPC-1072	75	122€	Intellectual Property Protection in Electronic Assembly Manufacturing
	CD	IPC-1072(E)1	54	105€	
	D	IPC-1072(D)1	-	115€	
1602	LIV	IPC-1602	110	196€	Standard for Printed Board Handling and Storage
	D	IPC-1602(D)1	-	179€	
1782A	LIV	IPC-1782A	150	209€	Standard for Manufacturing and Supply Chain Traceability of Electronic Products
	D	IPC-1782A(D)1	-	189€	
1791D	LIV	IPC-1791D	80	171€	Trusted Electronic Designer, Fabricator and Assembler Requirements
	D	IPC-1791D(D)1	-	158€	
2141A	D	IPC-2141A(D)1	-	152€	Design Guide for High-Speed Controlled Impedance Circuit Boards
2152	D	IPC-2152(D)1	-	189€	Standard for Determining Current Carrying Capacity in Printed Board Design
2221C	LIV	IPC-2221C	422	243€	Generic Standard on Printed Board Design
	D	IPC-2221C(D)1	-	219€	
2222B	LIV	IPC-2222B	120	169€	Sectional Design Standard for Rigid Organic Printed Boards
	D	IPC-2222B(D)1	-	156€	
2222B-FR	LIV	IPC-2222B-FR	120	290€	Norme Sectionnelle de Conception pour les Circuits Imprimés Organiques Rigides (French Language)
	D	IPC-2222B-FR(D)1	-	260€	
2223E	LIV	IPC-2223E	200	209€	Sectional Design Standard for Flexible / Rigid-Flexible Printed Boards
	D	IPC-2223E(D)1	-	189€	
2225	CD	IPC-2225(E)1	54	142€	Sectional Design Standard for Organic Multichip Modules (MCM-L) and MCM-L Assemblies
	D	IPC-2225(D)1	-	152€	
2226A	D	IPC-2226A(D)1	-	189€	Sectional Design Standard for High Density Interconnect (HDI) Boards
2228	LIV	IPC-2228	400	138€	Sectional Design Standard for High Frequency (RF/Microwave) Printed Boards
	D	IPC-2228(D)1	-	130€	
2231A	LIV	IPC-2231A	160	202€	DFX Guidelines
	D	IPC-2231A(D)1	-	186€	
2251	CD	IPC-2251(E)1	54	142€	Design Guide for the Packaging of High Speed Electronic Circuits
	D	IPC-2251(D)1	-	152€	

		REF IPC	Poids gr	PRIX €	TITRE
2291	CD	IPC-2291(E)1	54	105€	Design Guideline for Printed Electronics
	D	IPC-2291(D)1	-	115€	
2292A	LIV	IPC-2292A	300	209€	Design Standard for Printed Electronics on Flexible Substrates
	D	IPC-2292A(D)1	-	187€	
2581C	LIV	IPC-2581C	710	209€	Generic Requirements for Printed Board Assembly Products Manufacturing Description Data an Transfer Methodology
	D	IPC-2581C(D)1	-	189€	
2591-V1.7	LIV	IPC-2591-V1.7	250	207€	Connected Factory Exchange (CFX)
	D	IPC-2591-V1.7(D)1	-	187€	
2591-FR	LIV	IPC-2591-FR	150	305€	Echanges au Sein d'une Usine Connectée (CFX)
	D	IPC-2591-FR(D)1	-	270€	
2611	D	IPC-2611(D)1	-	115€	Generic Requirements for Electronic Product Documentation
2612	CD	IPC-2612(E)1	54	105€	Sectional Requirements for Electronic Diagramming Documentation (Schematic and Logic Descriptions)
	D	IPC-2612(D)1	-	115€	
2612-1	CD	IPC-2612-1(E)1	54	142€	Sectional Requirements for Electronic Diagramming Symbol Generation Methodology
	D	IPC-2612-1(D)1	-	152€	
2614	D	IPC-2614(D)1	-	152€	Sectional Requirements for Board Fabrication Documentation
2615	D	IPC-2615(D)1	-	152€	Printed Board Dimensions and Tolerances
4101E-WAM1	LIV	IPC-4101E-WAM1	490	217€	Specification for Base Materials for Rigid and Multilayer Printed Boards
	D	IPC-4101E-WAM1(D)1	-	189€	
4103B	D	IPC-4103B(D)1	-	158€	Specification for Base Materials for High Speed / High Frequency Applications
4104	D	IPC-4104(D)1	-	152€	Specification for High Density Interconnect (HDI) and Microvia Materials
4121	CD	IPC-4121(E)1	54	105€	Guidelines for Selecting Core Construction for Multilayer Printed Wiring Board Applications
	D	IPC-4121(D)1	-	115€	
4202C	LIV	IPC-4202C	100	122€	Specification for Flexible Base Dielectrics for use in Flexible Printed Boards
	D	IPC-4202C(D)1	-	115€	
4203B	D	IPC-4203B(D)1	-	158€	Cover and Bonding Material for Flexible Printed Circuitry
4204B	D	IPC-4204B(D)1	-	158€	Flexible Metal-Clad Dielectrics for Use in Fabrication of Flexible Printed Boards
4412C	LIV	IPC-4412C	100	122€	Specification for Finished Fabric Woven from "E" Glass for Printed Boards
	D	IPC-4412C(D)1	-	115€	
4552B	LIV	IPC-4552B	540	244€	Specification for Electroless Nickel/Immersion Gold (ENIG) Plating for Printed Circuit Boards
	D	IPC-4552B(D)1	-	220€	
4553A	CD	IPC-4553A(E)1	54	179€	Specification for Immersion Silver Plating for Printed Boards
	D	IPC-4553A(D)1	-	189€	
IPC-4554-WAM1	D	IPC-4554-WAM1(D)1	-	189€	Specification for Immersion Tin Plating for Printed Circuit Boards - With Amendment 1

		REF IPC	Poids gr	PRIX €	TITRE
4555	LIV	IPC-4555	240	138€	Performance Specification for High Temperature Organic Solderability Preservatives (OSP) for Printed Boards
	D	IPC-4555(D)1	-	130€	
4556	CD	IPC-4556(E)1	54	179€	Specification for Electroless Nickel/Electroless Palladium/Immersion Gold (ENEPIG) Plating for Printed Circuit Boards
	D	IPC-4556(D)1	-	189€	
4562A-WAM1	D	IPC-4562A-WAM1(D)1	-	152€	Metal Foil for Printed Board Applications
4591A	D	IPC-4591A(D)1	-	117€	Requirements for Printed Electronics Functional Conductive Materials
4781	D	IPC-4781(D)1	-	115€	Qualification and Performance Specification of Permanent, Semo-Permanent and Temporary Legend and/or Marking Ink
4921A	D	IPC-4921A(D)1	-	115€	Requirements for Printed Electronics Base Materials (Substrates)
5262	LIV	IPC-5262	70	171€	Design, Critical Process and Acceptance Requirements for Polymeric Applications
	D	IPC-5262(D)1	-	158€	
5703	D	IPC-5703(D)1	-	115€	Cleanliness Guidelines for Printed Board Fabricators
5704	D	IPC-5704(D)1	-	115€	Cleanliness Requirements for Unpopulated Printed Boards
6011	D	IPC-6011(D)1	-	115€	Generic Performance Specification for Printed Boards
6012F	LIV	IPC-6012F	140	217€	Qualification and Performance Specification for Rigid Printed Boards
	D	IPC-6012F(D)1	-	197€	
6012D-FR	CD	IPC-6012D-FR(E)1	54	282€	Spécification de la Qualification et des Performances des Circuits Imprimés Rigides
	D	IPC-6012D-FR(D)1	-	292€	
6012DS-FR	D	IPC-6012DS-FR(D)1	-	160€	Avenant pour les Applications Spatiales et Aéronautiques Militaires de l'IPC-6012D
6013E	LIV	IPC-6013E	165	209€	Qualification and Performance Specification for Flexible / Rigid-Flexible Printed Boards
	D	IPC-6013E(D)1	-	189€	
6015	CD	IPC-6015(E)1	54	105€	Qualification & Performance Specification for Organic Multichip Module (MCM-L) Mounting & Interconnecting Structures
	D	IPC-6015(D)1	-	115€	
6017A	LIV	IPC-6017A	100	122€	Qualification and Performance Specification for Printed Boards Containing Embedded Active and Passive Circuitry
	D	IPC-6017A(D)1	-	115€	
6018D	LIV	IPC-6018D	180	209€	Qualification and Performance Specification for High Frequency (Microwave) Printed Boards
	D	IPC-6018D(D)1	-	189€	
6901	D	IPC/JPCA-6901(D)1	-	115€	Application Categories for Printed Electronics
6903A	D	IPC-6903A(D)1	-	117€	Terms and Definitions for the Design and Manufacture of Printed Electronics
7090	LIV	IPC-7090-FAM (SERIE 7092 + 7093A + 7094A + 7095D-WAM1)	1740	749€	IPC-7090 Packages for PCBs and Assemblies
7091A	LIV	IPC-7091A	400	209€	Design and Assembly Process Implementation of 3D Components
	D	IPC-7091A(D)1	-	189€	

		REF IPC	Poids gr	PRIX €	TITRE
7092A	LIV	IPC-7092A	490	209€	Design and Assembly Process Implementation for Embedded Components
	D	IPC-7092A(D)1	-	189€	
7093A	LIV	IPC-7093A	500	209€	Design and Assembly Process Implementation for Bottom Termination Components (BTCs)
	D	IPC-7093A(D)1	-	189€	
7094A	D	IPC-7094A(D)1	-	189€	Design and Assembly Process Implementation for Flip Chip and Die Size Components
7095D-WAM1	LIV	IPC-7095D-WAM1	770	209€	Design and Assembly Process Implementation for BGAs, with Amendment 1
	D	IPC-7095D-WAM1(D)1	-	189€	
7351B	D	IPC-7351B(D)1	-	189€	Generic Requirements for Surface Mount Design and Land Pattern Standard
7525C	LIV	IPC-7525C	130	122€	Stencil Design Guidelines
	D	IPC-7525C(D)1	-	115€	
7527	D	IPC-7527(D)1	-	189€	Requirements for Solder Paste Printing
7530A	D	IPC-7530A(D)1	-	189€	Guidelines for Temperature Profiling for Mass Soldering Processes (Reflow & Wave)
7711/21D	LIV	IPC-7711/21D	1350	441€	Rework, Modification and Repair of Electronic Assemblies
	D	IPC-7711/21D(D)1	-	370€	
7711/21C-FR	D	IPC-7711/21C-FR(D)1	-	521€	Reprise, Modification et Réparation des Assemblages Electroniques
	LIV	IPC-7711/21C-AM1-FR	50	62€	
	D	IPC-7711/21C-AM1-FR(D)1	-	64€	
8497-1	D	IPC-8497-1(D)1	-	189€	Cleaning Methods and Contamination Assessment for Optical Assembly
8921	LIV	IPC-8921	110	197€	Requirements for Woven and Knitted Electronic Textiles (E-Textiles) Integrated with Conductive Fibers, Conductive Yarns and / or Wires
	D	IPC-8921(D)1	-	179€	
9111	LIV	IPC-9111	600	246€	Troubleshooting for Printed Board Assembly Processes
	D	IPC-9111(D)1	-	220€	
9121A	LIV	IPC-9121A	950	441€	Troubleshooting for PCB Fabrication Processes
	D	IPC-9121A(D)1	-	383€	
9191	CD	IPC-9191(E)1	54	142€	General Guidelines for Implementation of Statistical Process Control (SPC)
	D	IPC-9191(D)1	-	152€	
9201A	D	IPC-9201A(D)1	-	189€	Surface Insulation Resistance Handbook
9202A	LIV	IPC-9202A	40	122€	Material and Process Characterization / Qualification Test Protocol for Assessing Electrochemical Performance
	D	IPC-9202A(D)1	-	115€	
9203A	LIV	IPC-9203A	200	209€	Users Guide to IPC-9202 and the IPC-B-52 Standard Test Vehicle
	D	IPC-9203A(D)1	-	189€	
9204	CD	IPC-9204(E)1	54	97€	Guideline on Flexibility and Stretchability Testing for Printed Electronics
	D	IPC-9204(D)1	-	107€	
9241	D	IPC-9241(D)1	-	189€	Guidelines for Microsection Preparation
9252B	D	IPC-9252B(D)1	-	115€	Requirements for Electrical Testing of Unpopulated Printed Boards

		REF IPC	Poids gr	PRIX €	TITRE
9257	LIV	IPC-9257	105	169€	Requirements for Electrical Testing of Flexible Printed Electronics
	D	IPC-9257(D)1	-	156€	
9301	LIV	IPC-9301	350	199€	IPC/JEDEC Numerical Analysis Guidelines for Microelectronics Packaging Design and Reliability
	D	IPC-9301(D)1	-	181€	
9505	D	IPC-9505(D)1	-	117€	Guideline Methodology for Assessing Component and Cleaning Materials Compatibility
9641	CD	IPC-9641(E)1	54	107€	High Temperature Printed Board Flatness Guideline
	D	IPC-9641(D)1	-	117€	
9691B	D	IPC-9691B(D)1	-	189€	User Guide for the IPC-TM-650, Method 2.6.25, Conductive Anodic Filament (CAF) Resistance Test (Electrochemical Migration Testing)
9701A	CD	IPC-9701A(E)1	54	105€	Performance Test Methods and Qualification Requirements for Surface Mount Solder Attachments
	D	IPC-9701A(D)1	-	115€	
9704A	CD	IPC-9704A(E)1	54	179€	Printed Circuit Assembly Strain Gage Test Guideline
	D	IPC-9704A(D)1	-	189€	
9708	D	IPC-9708(D)1	-	189€	Test Methods for Characterization of Printed Board Assembly Pad Cratering
9709A	LIV	IPC-9709A	59	209€	Guidelines for Acoustic Emission Measurement Method during Mechanical Testing
	D	IPC-9709A(D)1	-	189€	
9797A	LIV	IPC-9797A	180	197€	Press-fit Standard for Automotive Requirements and other High-Reliability Applications
	D	IPC-9797A(D)1	-	179€	
HERMES-9852	LIV	IPC-HERMES-9852 V1.5	200	196€	The Global Standard for Machine-to-Machine Communication in SMT Assembly
	D	IPC-HERMES-9852(D)1 V1.5	-	17€	
A-600K	LIV	IPC-A-600K	760	337€	Acceptability of Printed Boards
	D	IPC-A-600K(D)1	-	281€	
A-600K-FR	LIV	IPC-A-600K-FR	760	484€	Acceptabilité des Circuits Imprimés (French language)
	D	IPC-A-600K-FR(D)1	-	404€	
A-610J	D	IPC-A-610J(D)1	-	281€	Acceptability of Electronic Assemblies
A-610H	LIV	IPC-A-610H	1260	337€	Acceptability of Electronic Assemblies
	D	IPC-A-610H(D)1	-	281€	
A-610H-FR	LIV	IPC-A-610H-FR	1500	484€	Acceptabilité des assemblages électroniques (French Language)
	D	IPC-A-610H-FR(D)1	-	403€	
A-620E	LIV	IPC/WHMA-A-620E	1400	337€	Requirements and Acceptance for Cable and Wire Harness Assemblies
	D	IPC/WHMA-A-620E(D)1	-	281€	
A-620D-FR	LIV	IPC/WHMA-A-620D-FR	1480	484€	Exigences et Acceptation des Assemblages de Câbles et de Faisceaux de Fils (French Language)
	D	IPC/WHMA-A-620D-FR(D)1	-	403€	
A-630	D	IPC-A-630(D)1	-	179€	Acceptability Standard for Manufacture, Inspection and Testing of Electronic Enclosures
IPC-A-640A	LIV	IPC-A-640A	700	209€	Acceptance Requirements for Optical Fiber, Optical Cable, and Hybrid Wiring Harness Assemblies
	D	IPC-A-640A(D)1	-	189€	
AJ-820A	LIV	IPC-AJ-820A	1028	209€	Assembly & Joining Handbook
	D	IPC-AJ-820A(D)1	-	189€	

		REF IPC	Poids gr	PRIX €	TITRE
CC-830C	LIV	IPC-CC-830C	500	122€	Qualification and Performance of Electrical Insulating Compound for Printed Wiring Assemblies
	D	IPC-CC-830C(D)1	-	115€	
CH-65B	D	IPC-CH-65B(D)1	-	189€	Guidelines for Cleaning of Printed Boards and Assemblies
D-620A	LIV	IPC-D-620A	250	209€	Design and Critical Process Requirements for Cable and Wiring Harnesses (kit products : WP-113A, WP-114A, WP-116A)
	D	IPC-D-620A(D)1	-	189€	
D-640A	LIV	IPC-D-640A	200	209€	Design and Critical Process Requirements for Optical Fiber, Optical Cable and Hybrid Wiring Harness assemblies
	D	IPC-D-640A(D)1	-	189€	
IPC-DR-DES-2022	LIV	IPC-DR-DES-2022	100	128€	PCB Design Desk Reference 2022 Edition
IPC-DR-DES-2022-FR	LIV	IPC-DR-DES-2022-FR	100	128€	PCB Design Desk Reference 2022 Edition
IPC-QRG-18J	LIV	IPC-QRG-18J	183	82€	Component Identification Training and Reference Guide
	D	IPC-QRG-18J(D)1	-	80€	
QRG-PTH-H	LIV	IPC-QRG-PTH-H	100	82€	Through-Hole SolderJoint Evaluation Training & Reference Guide
	D	IPC-QRG-PTH-H(D)1	-	80€	
IPC-SMT-H	LIV	IPC-QRG-SMT-H	115	82€	Surface Mount Solder Joint Evaluation Training & Reference Guide
	D	IPC-QRG-SMT-H(D)1	-	80€	
QRG-WHA-D	LIV	IPC-QRG-WHA-D	160	82€	Wire Harness Assembly Training & Reference Guide
	D	IPC-QRG-WHA-D(D)1	-	80€	
HDBK-001H	LIV	IPC-HDBK-001H	600	263€	Handbook and Guide to Supplement IPC-J-STD-001
	D	IPC-HDBK-001H(D)1	-	235€	
HDBK-005	D	IPC-HDBK-005(D)1	-	189€	Guide to Solder Paste Assessment
HDBK-620	LIV	IPC-HDBK-620	870	246€	Handbook and Guide to IPC-D-620 & IPC/WHMA-A-620
	D	IPC-HDBK-620(D)1	-	220€	
HDBK-630	D	IPC-HDBK-630(D)1	-	189€	Guidelines for Design, Manufacture, Inspection and Testing of Electronic Enclosures
HDBK-830A	D	IPC-HDBK-830A(D)1	-	189€	Guidelines for Design, Selection and Application of Conformal Coatings
HDBK-840	CD	IPC-HDBK-840(E)1	54	179€	Solder Mask Handbook
	D	IPC-HDBK-840(D)1	-	189€	
HDBK-850	D	IPC-HDBK-850(D)1	-	189€	Guidelines for Design, Selection and Application of Potting Materials and Encapsulation Processes Used for Electronics Printed Circuit Board Assembly
HDBK-9798	LIV	IPC-HDBK-9798	400	171€	Handbook for Press-Fit Standard for Automotive Requirements and other High-Reliability Applications
	D	IPC-HDBK-9798(D)1	-	158€	
JP002	CD	IPC-JP002(E)1	54	105€	JEDEC/IPC Current Tin Whiskers Theory and Mitigation Practices Guideline
	D	IPC-JP002(D)1	-	115€	
J-STD-001H	LIV	IPC-J-STD-001H	230	279€	Requirements for Soldered Electrical and Electronic Assemblies
	D	IPC-J-STD-001H(D)1	-	220€	
J-STD-001J	D	IPC-J-STD-001J(D)1	-	220€	Requirements for Soldered Electrical and Electronic Assemblies
J-STD-001H-FR	LIV	IPC-J-STD-001H-FR	300	375€	Exigences Relatives aux Assemblages Electroniques et Electriques Brasés (French Language)
	D	IPC-J-STD-001H-FR(D)1	-	314€	
J-STD-002E	LIV	IPC-J-STD-002E	150	171€	EIA/IPC/JEDEC J-STD-002D Solderability Tests for Component Leads, Terminations, Lugs, Terminals and Wires
	D	IPC-J-STD-002E(D)1	-	158€	

		REF IPC	Poids gr	PRIX €	TITRE
J-STD-003D	LIV	IPC-J-STD-003D	250	209€	Solderability Tests for Printed Boards
	D	IPC-J-STD-003D(D)1	-	189€	
J-STD-004C	LIV	IPC-J-STD-004C	160	209€	Requirements for Soldering Fluxes
J-STD-004D	D	IPC-J-STD-004D(D)1	-	189€	Requirements for Soldering Fluxes
J-STD-005B	D	IPC-J-STD-005B(D)1	-	115€	Requirements for Soldering Pastes
J-STD-006C	D	IPC-J-STD-006C(D)1	-	115€	Requirements for Electronic Grade Solder Alloys and Fluxed and Non-Fluxed Solid Solders for Electronic Soldering Applications
J-STD-020F	LIV	IPC-J-STD-020F	120	122€	IPC/JEDEC Moisture/Reflow Sensitivity Classification for Non-hermetic Surface Mount Devices
	D	IPC-J-STD-020F(D)1	-	115€	
J-STD-030A	CD	IPC-J-STD-030A(E)1	54	179€	Selection and Application of Board Level Underfill Materials
	D	IPC-J-STD-030A(D)1	-	189€	
J-STD-033D	LIV	IPC-J-STD-033D	100	122€	Handling, Packing, Shipping and Use of Moisture/Reflow Sensitive Surface Mount Devices
	D	IPC-J-STD-033D(D)1	-	115€	
J-STD-075A	LIV	IPC-J-STD-075A	160	124€	Classification of Non-IC Electronic Components for Assembly Processes
	D	IPC-J-STD-075A(D)1	-	117€	
J-STD-609B	D	IPC-J-STD-609B(D)1	-	115€	Marking and Labeling of Components, PCBs and PCBAs to Identify Lead (Pb), Lead-Free (Pb-Free) and Other Attributes
PE-740A	CD	IPC-PE-740A(E)1	54	179€	Troubleshooting for Printed Board Manufacture and Assembly
	D	IPC-PE-740A(D)1	-	189€	
QE-605A	D	IPC-QE-605A(D)1	-	189€	Printed Board Quality Evaluation
SM-784	D	IPC-SM-784(D)1	-	152€	Guidelines for Chip-on-Board Technology Implementation
SM-785	CD	IPC-SM-785(E)1	54	142€	Guidelines for Accelerated Reliability Testing of Surface Mount Attachments
	D	IPC-SM-785(D)1	-	152€	
SM-817A	D	IPC-SM-817A(D)1	-	115€	General Requirements for Dielectric Surface Mount Adhesives
SM-840E	D	IPC-SM-840E(D)1	-	115€	Qualification and Performance Specification of Permanent Solder Mask and Flexible Cover Materials
T-50N	LIV	IPC-T-50N	330	209€	Terms and Definitions for Interconnecting and Packaging Electronic Circuits
	D	IPC-T-50N(D)1	-	189€	
T-50M-FR	D	IPC-T-50M-FR(D)1	-	250€	Termes et Définitions pour les Circuits Electroniques Imprimés et Assemblés (French Language)
IPC-T-51	LIV	IPC-T-51	80	122€	Terms and Definitions for Design and Manufacture of Printed Electronics
	D	IPC-T-51(D)1	-	115€	
WP-019B	LIV	IPC-WP-019B	103	117€	An Overview on the Global Change in Ionic Cleanliness Requirements
	D	IPC-WP-019B(D)1	-	111€	
WP-019A-FR	LIV	IPC-WP-019A-FR	90	167€	Présentation des Modifications Générales des Exigences en Matière de Propreté ionique
	D	IPC-WP-019A-FR(D)1	-	154€	